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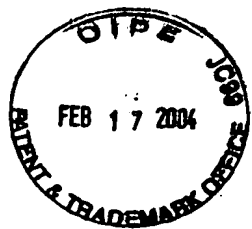
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Customer No.: 31561  
Application No.: 10/604,409  
Docket No.: 10672-US-PA

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In Re Application of:	)	
	)	
Lee <i>et al.</i>	)	Examiner : Nathan W. Ha
	)	
Serial No.: 10/604,409	)	Art Unit : 2814
	)	
Filed : 07/18/2003	)	Docket No.: 10672-US-PA
	)	
For : <b>Stack Chip Package Structure</b>	)	
	)	

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No fee is believed to be due. However, the Commissioner is authorized to charge any fees required in connection with the filing of this paper to account No. 50-2620 (Order No. 10672-US-PA).

**AMENDMENTS AND RESPONSE TO OFFICE ACTION**

U.S. Patent and Trademark Office  
Commissioner for Patents  
2011 South Clark Place  
Customer Window, Mail Stop **Non-Fee Amendment**  
Crystal Plaza Two, Lobby, Room 1B03  
Arlington, Virginia 22202

Dear Sir:

The Office Action mailed on November 28, 2003 has been carefully considered. In response thereto, please consider the following remarks.



Patent

Customer No.: 31561  
Docket No. 10672-US-PA  
Application No.: 10/604,409

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re application of

Applicant : Lee et al.  
Application No. : 10/604,409  
Filed : July 18, 2003  
For : STACK CHIP PACKAGE STRUCTURE  
Art Unit : 2814  
Examiner : NATHAN, W. HA

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**TRANSMITTAL LETTER**

**002-1-703-872-9306**

**(Via fax: 8 pages, followed by confirmation copy via courier)**

Assistant Commissioner For Patents  
Arlington, Virginia 22202

Dear Sirs,

In response to the Office Action dated November 28, 2003, please find the relevant paper in response to paper No. 20031103. Following the fax transmission, a hard copy via courier will also be forwarded to the Office.

Enclosed documents via courier will include:

- ☒ Amendment and Response to Office Action in (6) pages
- ☒ Fax confirmation report
- ☒ Prepaid return postcard
- ☐ Extension fee

I believe that no fee is incurred. However, the Commissioner is authorized to charge any fees required in connection with the filing of this paper to account No. 50-2620 (Order No.: 10672-US-PA)

Thank you for your assistance in the subject matter. If you have any questions, please feel free to contact me.

**Patent**

Customer No.: 31561  
Docket No. 10672-US-PA  
**Application No.: 10/604,409**

Respectfully Submitted,  
JIANQ CHYUN Intellectual Property Office

Date: Feb. 14, 2004

By: Belinda Lee  
Belinda Lee  
Registration No.: 46,863

**Please send future correspondence to:**  
**7F. -1, No. 100, Roosevelt Rd.,**  
**Sec. 2, Taipei 100, Taiwan, R.O.C.**  
**Tel: 886-2-2369 2800**  
**Fax: 886-2-2369 7233 / 886-2-2369 7234**



TRANSACTION REPORT

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Patent

Customer No.: 31561  
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